

Power MOS Field-Effect Transistors

N-Channel Enhancement-Mode Power Field-Effect Transistors

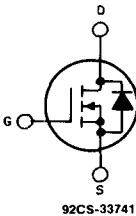
7.0A and 8.0A, 60V-100V  
 $r_{DS(on)} = 0.30\ \Omega$  and  $0.40\ \Omega$

- Features:
- SOA is power-dissipation limited
  - Nanosecond switching speeds
  - Linear transfer characteristics
  - High input impedance
  - Majority carrier device

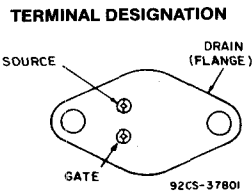
The IRF120, IRF121, IRF122 and IRF123 are n-channel enhancement-mode silicon-gate power field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

The IRF-types are supplied in the JEDEC TO-204AA steel package.

N-CHANNEL ENHANCEMENT MODE



TERMINAL DIAGRAM



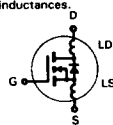
JEDEC TO-204AA

Absolute Maximum Ratings

| Parameter                                                         | IRF120                                      | IRF121 | IRF122 | IRF123 | Units               |
|-------------------------------------------------------------------|---------------------------------------------|--------|--------|--------|---------------------|
| $V_{DS}$ Drain - Source Voltage ①                                 | 100                                         | 60     | 100    | 60     | V                   |
| $V_{DGR}$ Drain - Gate Voltage ( $R_{GS} = 20\text{ K}\Omega$ ) ① | 100                                         | 60     | 100    | 60     | V                   |
| $I_D @ T_C = 25^\circ\text{C}$ Continuous Drain Current           | 8.0                                         | 8.0    | 7.0    | 7.0    | A                   |
| $I_D @ T_C = 100^\circ\text{C}$ Continuous Drain Current          | 5.0                                         | 5.0    | 4.0    | 4.0    | A                   |
| $I_{DM}$ Pulsed Drain Current ③                                   | 32                                          | 32     | 28     | 28     | A                   |
| $V_{GS}$ Gate - Source Voltage                                    | $\pm 20$                                    |        |        |        | V                   |
| $P_D @ T_C = 25^\circ\text{C}$ Max. Power Dissipation             | 40 (See Fig. 14)                            |        |        |        | W                   |
| Linear Derating Factor                                            | 0.32 (See Fig. 14)                          |        |        |        | W/ $^\circ\text{C}$ |
| $I_{LM}$ Inductive Current, Clamped                               | (See Fig. 15 and 16) $L = 100\ \mu\text{H}$ |        |        |        | A                   |
|                                                                   | 32                                          | 32     | 28     | 28     |                     |
| $T_J$ Operating Junction and                                      | $-55$ to $150$                              |        |        |        | $^\circ\text{C}$    |
| $T_{stg}$ Storage Temperature Range                               |                                             |        |        |        |                     |
| Lead Temperature                                                  | 300 (0.063 in. (1.6mm) from case for 10s)   |        |        |        | $^\circ\text{C}$    |

## IRF120, IRF121, IRF122, IRF123

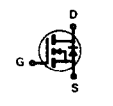
Electrical Characteristics @  $T_C = 25^\circ\text{C}$  (Unless Otherwise Specified)

| Parameter                                              | Type             | Min. | Typ. | Max. | Units         | Test Conditions                                                                                                                                                                       |
|--------------------------------------------------------|------------------|------|------|------|---------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $BV_{DSS}$ Drain-Source Breakdown Voltage              | IRF120<br>IRF122 | 100  | —    | —    | V             | $V_{GS} = 0\text{V}$<br>$I_D = 250\mu\text{A}$                                                                                                                                        |
|                                                        | IRF121<br>IRF123 | 60   | —    | —    | V             |                                                                                                                                                                                       |
| $V_{GS(th)}$ Gate Threshold Voltage                    | ALL              | 2.0  | —    | 4.0  | V             | $V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$                                                                                                                                            |
| $I_{GSS}$ Gate-Source Leakage Forward                  | ALL              | —    | —    | 100  | nA            | $V_{GS} = 20\text{V}$                                                                                                                                                                 |
| $I_{GSS}$ Gate-Source Leakage Reverse                  | ALL              | —    | —    | -100 | nA            | $V_{GS} = -20\text{V}$                                                                                                                                                                |
| $I_{DSS}$ Zero Gate Voltage Drain Current              | ALL              | —    | —    | 250  | $\mu\text{A}$ | $V_{DS} = \text{Max. Rating}$ , $V_{GS} = 0\text{V}$                                                                                                                                  |
|                                                        |                  | —    | —    | 1000 | $\mu\text{A}$ | $V_{DS} = \text{Max. Rating} \times 0.8$ , $V_{GS} = 0\text{V}$ , $T_C = 125^\circ\text{C}$                                                                                           |
| $I_{D(on)}$ On-State Drain Current ②                   | IRF120<br>IRF121 | 8.0  | —    | —    | A             | $V_{DS} > I_{D(on)} \times R_{DS(on) \text{ max.}}$ , $V_{GS} = 10\text{V}$                                                                                                           |
|                                                        | IRF122<br>IRF123 | 7.0  | —    | —    | A             |                                                                                                                                                                                       |
| $R_{DS(on)}$ Static Drain-Source On-State Resistance ② | IRF120<br>IRF121 | —    | 0.25 | 0.30 | $\Omega$      | $V_{GS} = 10\text{V}$ , $I_D = 4.0\text{A}$                                                                                                                                           |
|                                                        | IRF122<br>IRF123 | —    | 0.30 | 0.40 | $\Omega$      |                                                                                                                                                                                       |
| $g_{fs}$ Forward Transconductance ②                    | ALL              | 1.5  | 2.9  | —    | S (④)         | $V_{DS} > I_{D(on)} \times R_{DS(on) \text{ max.}}$ , $I_D = 4.0\text{A}$                                                                                                             |
| $C_{iss}$ Input Capacitance                            | ALL              | —    | 450  | —    | pF            | $V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1.0\text{MHz}$<br>See Fig. 10                                                                                                     |
| $C_{oss}$ Output Capacitance                           | ALL              | —    | 200  | —    | pF            |                                                                                                                                                                                       |
| $C_{rss}$ Reverse Transfer Capacitance                 | ALL              | —    | 50   | —    | pF            |                                                                                                                                                                                       |
| $t_{d(on)}$ Turn-On Delay Time                         | ALL              | —    | 20   | 40   | ns            | $V_{DD} = 0.5 BV_{DSS}$ , $I_D = 4.0\text{A}$ , $Z_\theta = 50^\circ\text{C}$<br>See Fig. 17                                                                                          |
| $t_r$ Rise Time                                        | ALL              | —    | 35   | 70   | ns            | (MOSFET switching times are essentially independent of operating temperature.)                                                                                                        |
| $t_{d(off)}$ Turn-Off Delay Time                       | ALL              | —    | 50   | 100  | ns            |                                                                                                                                                                                       |
| $t_f$ Fall Time                                        | ALL              | —    | 35   | 70   | ns            |                                                                                                                                                                                       |
| $Q_g$ Total Gate Charge (Gate-Source Plus Gate-Drain)  | ALL              | —    | 10   | 15   | nC            | $V_{GS} = 10\text{V}$ , $I_D = 10\text{A}$ , $V_{DS} = 0.8 \text{ Max. Rating}$ .<br>See Fig. 18 for test circuit. (Gate charge is essentially independent of operating temperature.) |
| $Q_{gs}$ Gate-Source Charge                            | ALL              | —    | 6.0  | 9.0  | nC            |                                                                                                                                                                                       |
| $Q_{gd}$ Gate-Drain ("Miller") Charge                  | ALL              | —    | 4.0  | 6.0  | nC            |                                                                                                                                                                                       |
| $L_D$ Internal Drain Inductance                        | ALL              | —    | 5.0  | —    | nH            | Measured between the contact screw on header that is closer to source and gate pins and center of die.<br><br>Modified MOSFET symbol showing the internal device inductances.         |
| $L_S$ Internal Source Inductance                       | ALL              | —    | 12.5 | —    | nH            | Measured from the source pin, 6 mm (0.25 in.) from header and source bonding pad.<br><br>          |

## Thermal Resistance

|                                |     |   |     |      |                    |                                             |
|--------------------------------|-----|---|-----|------|--------------------|---------------------------------------------|
| $R_{thJC}$ Junction-to-Case    | ALL | — | —   | 3.12 | $^\circ\text{C/W}$ |                                             |
| $R_{thCS}$ Case-to-Sink        | ALL | — | 0.1 | —    | $^\circ\text{C/W}$ | Mounting surface flat, smooth, and greased. |
| $R_{thJA}$ Junction-to-Ambient | ALL | — | —   | 30   | $^\circ\text{C/W}$ | Free Air Operation                          |

## Source-Drain Diode Ratings and Characteristics

|                                              |                  |                                                                                                  |     |     |               |                                                                                                                                                                          |
|----------------------------------------------|------------------|--------------------------------------------------------------------------------------------------|-----|-----|---------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $I_S$ Continuous Source Current (Body Diode) | IRF120<br>IRF121 | —                                                                                                | —   | 8.0 | A             | Modified MOSFET symbol showing the integral reverse P-N junction rectifier.<br><br> |
|                                              | IRF122<br>IRF123 | —                                                                                                | —   | 7.0 | A             |                                                                                                                                                                          |
| $I_{SM}$ Pulse Source Current (Body Diode) ③ | IRF120<br>IRF121 | —                                                                                                | —   | 32  | A             |                                                                                                                                                                          |
|                                              | IRF122<br>IRF123 | —                                                                                                | —   | 28  | A             |                                                                                                                                                                          |
| $V_{SD}$ Diode Forward Voltage ②             | IRF120<br>IRF121 | —                                                                                                | —   | 2.5 | V             | $T_C = 25^\circ\text{C}$ , $I_S = 8.0\text{A}$ , $V_{GS} = 0\text{V}$                                                                                                    |
|                                              | IRF122<br>IRF123 | —                                                                                                | —   | 2.3 | V             | $T_C = 25^\circ\text{C}$ , $I_S = 7.0\text{A}$ , $V_{GS} = 0\text{V}$                                                                                                    |
| $t_{rr}$ Reverse Recovery Time               | ALL              | —                                                                                                | 280 | —   | ns            | $T_J = 150^\circ\text{C}$ , $I_F = 8.0\text{A}$ , $di_F/dt = 100\text{A}/\mu\text{s}$                                                                                    |
| $Q_{RR}$ Reverse Recovered Charge            | ALL              | —                                                                                                | 1.6 | —   | $\mu\text{C}$ | $T_J = 150^\circ\text{C}$ , $I_F = 8.0\text{A}$ , $di_F/dt = 100\text{A}/\mu\text{s}$                                                                                    |
| $t_{on}$ Forward Turn-on Time                | ALL              | Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$ . |     |     |               |                                                                                                                                                                          |

①  $T_J = 25^\circ\text{C}$  to  $150^\circ\text{C}$ . ② Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .③ Repetitive Rating: Pulse width limited by max. junction temperature.  
See Transient Thermal Impedance Curve (Fig. 5).

## IRF120, IRF121, IRF122, IRF123

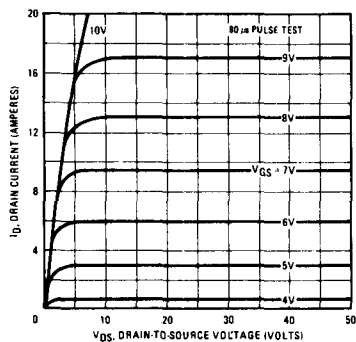


Fig. 1 - Typical Output Characteristics

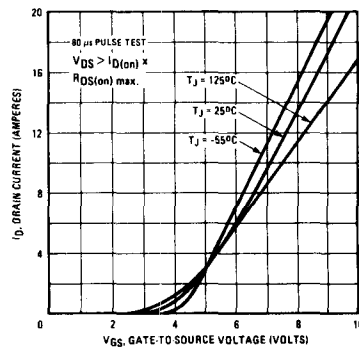


Fig. 2 - Typical Transfer Characteristics

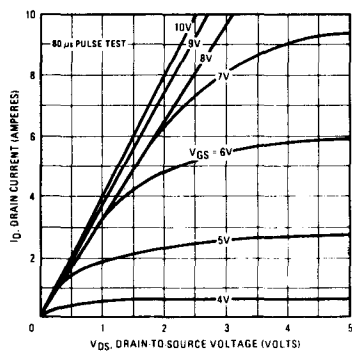


Fig. 3 - Typical Saturation Characteristics

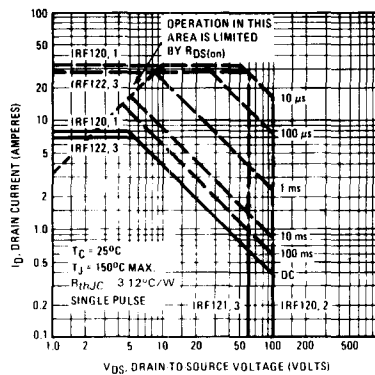


Fig. 4 - Maximum Safe Operating Area

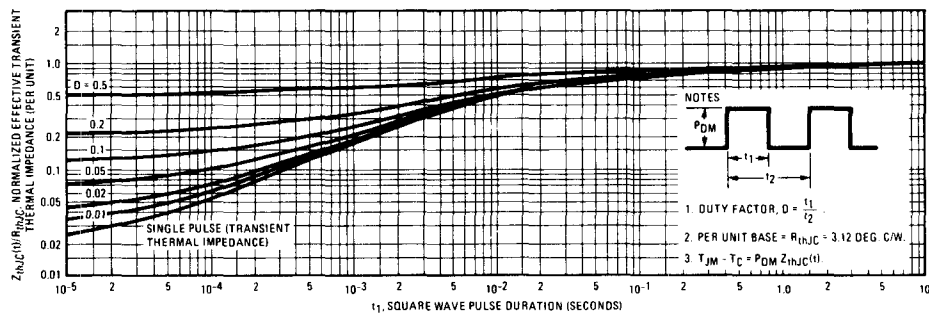


Fig. 5 - Maximum Effective Transient Thermal Impedance, Junction-to-Case Vs. Pulse Duration

## IRF120, IRF121, IRF122, IRF123

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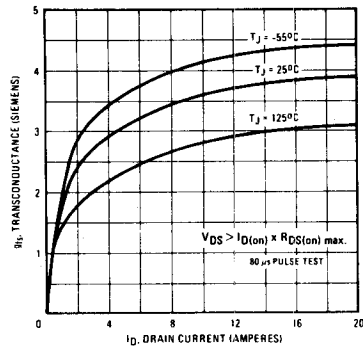


Fig. 6 – Typical Transconductance Vs. Drain Current

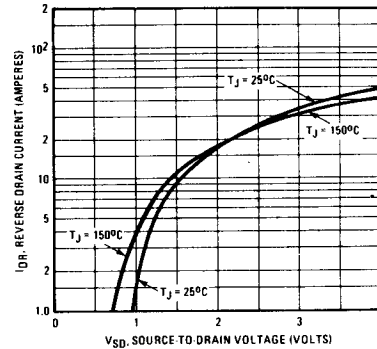


Fig. 7 – Typical Source-Drain Diode Forward Voltage

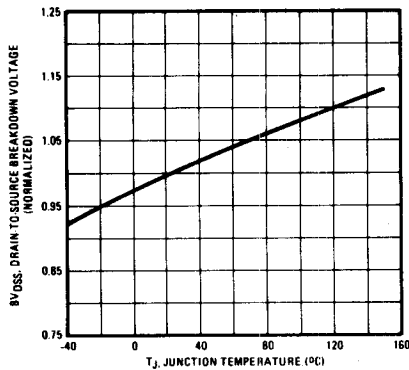


Fig. 8 – Breakdown Voltage Vs. Temperature

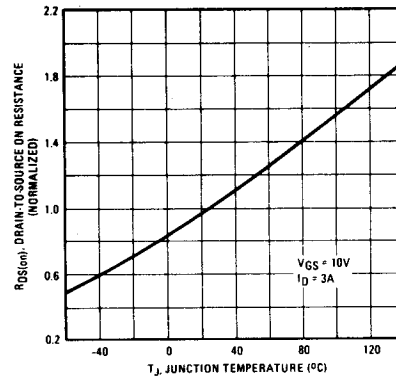


Fig. 9 – Normalized On-Resistance Vs. Temperature

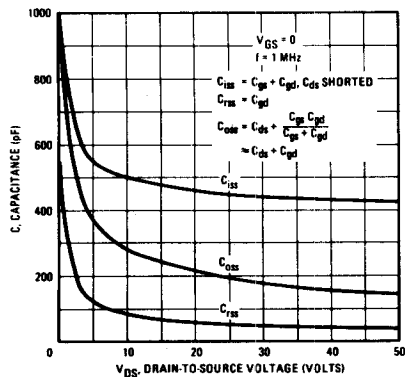


Fig. 10 – Typical Capacitance Vs. Drain-to-Source Voltage

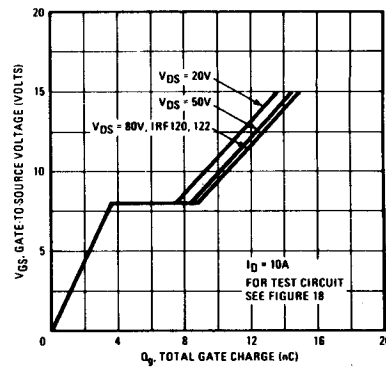


Fig. 11 – Typical Gate Charge Vs. Gate-to-Source Voltage

## IRF120, IRF121, IRF122, IRF123

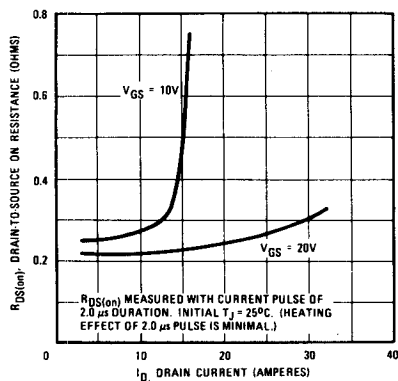


Fig. 12 - Typical On-Resistance Vs. Drain Current

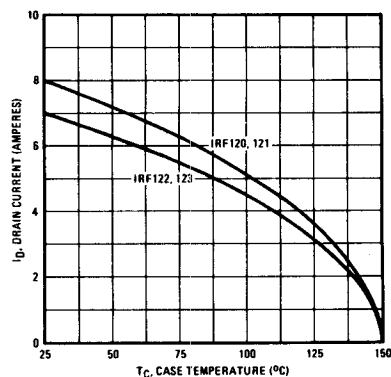


Fig. 13 - Maximum Drain Current Vs. Case Temperature

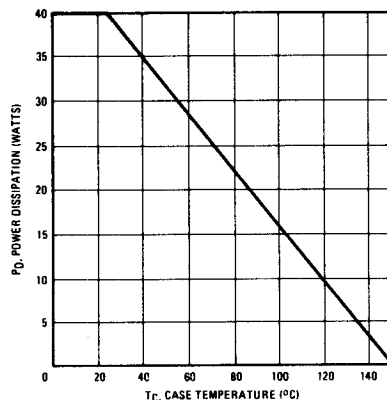


Fig. 14 - Power Vs. Temperature Derating Curve

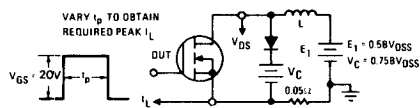


Fig. 15 - Clamped Inductive Test Circuit



Fig. 16 - Clamped Inductive Waveforms

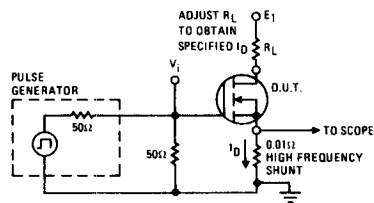


Fig. 17 - Switching Time Test Circuit

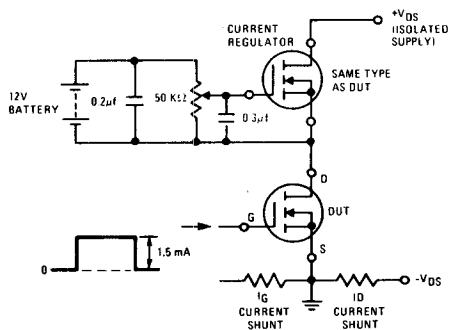


Fig. 18 - Gate Charge Test Circuit